

# Scanning the Issue

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## Special Issue on 3-D Technologies for Imaging and Display

Three-dimensional (3-D) imaging, display, and visualization are considered to be important applications of information systems in a society that is increasingly dependent on the presentation of information. There are broad applications of these technologies in computer display, communication, TV, video, entertainment, robotics, metrology, reconnaissance, defense, homeland security, healthcare, and medicine.

Ideal 3-D imaging, visualization, and display, in particular moving/dynamic scenes, are one of the goals for future technologies because of their diverse and significant applications. Developing technologies to display high quality 3-D scenes, especially dynamic scenes, is a difficult problem. The main challenges are to address resolution, depth of focus, view angle, compactness, cost, bandwidth, human factors, and real-time operation.

Attempts were made to produce stereoscopic effects in paintings even before photographic technology was fully developed. Science fiction motion pictures frequently use 3-D imaging and display to enhance special effects. Initial attempts to generate moving stereoscopic images were for movie production. Video technology is increasingly being exploited to produce moving pictures with 3-D effects. In addition, 3-D virtual reality applications are attracting great interest, and many experimental systems have been reported. Three-dimensional moving picture systems are increasingly in demand for various applications in entertainment, industry, and medicine. Some of these systems have already matured to a practical level. However, very high quality 3-D image systems still face challenges to implement.

With the rapid advances in optical display monitors, electronic/optoelectronic hardware and software technologies, many 3-D imaging and 3-D display techniques can now be implemented with commercially available off-the-shelf components and can be used for diverse commercial applications. A number of experimental 3-D moving picture systems have been proposed and developed. Depending on the characteristics of the reproduced 3-D images, they can be classified into three types: binocular, multi-view, and spatial image reproduction. Each of these is a complex technology that combines optical, electronic, display, and image sensor technologies. In addition, there are active image sensing

(capture) systems such as holographic techniques which require laser illumination sources, as well as passive image capture systems such as multi view imaging approach that can operate under ambient light. These technologies are multidisciplinary and incorporate knowledge from the fields of optics, communication, optoelectronics, electronics, signal processing, and psychological science.

The overview papers in this special issue are contributed by some of the leaders in the field of 3-D imaging and display. They are intended to present fundamental ideas, theory, experiments, and applications of some of the leading 3-D techniques. In addition, they are intended to provide examples, simulations, and experimental results to illustrate the main concepts.

The paper by Okano *et al.* discusses practical issues in implementation of integral imaging systems. Son *et al.* present an overview paper on various methods and essential components of generating 3-D images. The paper by Fehn *et al.* provides an overview on recent trends in 3-D TV including an experimental 3DTV system that is based on the joint distribution of monoscopic color video and associated per-pixel depth information.

Travis *et al.* describe how to project 3-D images within inexpensive flat panels by pointing a projector into a wedge-shaped light-guide to time-multiplex a 3-D image on a large screen. Yeom *et al.* present automated optical imaging techniques for real-time 3-D visualization, identification, and monitoring of moving biological microorganisms in dynamic scenes. Eden's review focuses on selected emissive display technologies: plasma display panels, field emission and surface-conduction electron emission displays, and microcavity plasma arrays. In their paper, Hill *et al.* discuss 3-D LCDs and their applications based on parallel barrier method. The paper by Stern *et al.* provides an overview of the recent approaches and techniques developed to overcome limitations of Integral Imaging systems in terms of resolution, depth of focus, and view angle for 3-D imaging and display. Itoh *et al.* describe coherence based 3-D imaging, spectral imaging, and laser scanning microscopy.

Otsuka *et al.* present a method for 360° viewable 3-D displays based on multiple image scene projection onto a spinning screen. Frauel *et al.*'s paper reviews various applications of 3-D imaging, visualization, display, processing, encryption, and recognition using digital holographic techniques.

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Takaki's paper describes a high-density directional display to produce 3-D images by projecting a large number of directional images using directional rays.

Clearly, the subject of 3-D imaging and display is very broad and it is not possible to cover every existing approach and/or R&D activity in a single special issue. However, we hope that this issue will be useful for students, engineers, scientists, and managers who are interested in this important field. There is a large community dedicated to R&D on imaging and display systems who may benefit from learning about the advances in the rapidly evolving field of 3-D imaging and display. This issue attempts to address these interests by providing an overview of recent advances in 3-D imaging, display, TV, and visualization.

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BAHRAM JAVIDI  
University of Connecticut  
Storrs, CT 06269 USA

FUMIO OKANO  
NHK Science and Technical  
Research Laboratories  
Tokyo 157-8510, Japan



**Bahram Javidi** (Fellow, IEEE) received the B.S. degree in electrical engineering from George Washington University, Washington, DC, and the M.S. and Ph.D. degrees in electrical engineering from the Pennsylvania State University, University Park.

He is Board of Trustees Distinguished Professor at the University of Connecticut, Storrs. He has supervised over 80 masters and doctoral graduate students, postdoctoral students, and visiting professors during his academic career. He has published over 200 technical articles in major journals. He has published over 230 conference proceedings, including over 90 invited conference papers, and 60 invited presentations. His papers have been cited over 2600 times, according to the citation index of *WEB of Science*. His papers have appeared in *Physics Today* and *Nature*, and his research has been cited in the *Frontiers in Engineering Newsletter*, published by the National Academy of Engineering, *IEEE Spectrum*, *Science*, *New Scientist*, and *National Science Foundation Newsletter*. He has completed several books including, *Optical Imaging Sensors and Systems for Homeland Security Applications* (Springer, 2005); *Optical and Digital Techniques*

*For Information Security* (Springer, 2005); *Image Recognition: Algorithms, Systems, and Applications* (Marcel Dekker, 2002); *Three Dimensional Television, Video, and Display Technologies* (Springer-Verlag, 2002); *Smart Imaging Systems* (SPIE Press, 2001); *Real-Time Optical Information Processing* (Academic Press, 1994), *Optical Pattern Recognition* (SPIE Press, 1994). He is currently the Editor in Chief of the Springer Verlag series on Advanced Science and Technologies for Security Applications. He has served as topical editor for Springer-Verlag, Marcel Dekker publishing company, *Optical Engineering Journal*, and IEEE/SPIE Press Series on Imaging Science and Engineering. He has held visiting positions during his sabbatical leave at Massachusetts Institute of Technology, United States Air Force Rome Lab at Hanscom Base, and Thomson-CSF Research Labs in Orsay, France. He is a consultant to industry in the areas of optical systems, image recognition systems, and 3-D optical imaging systems. He has active research collaborations with numerous universities and industries in the United States, Japan, South Korea, Italy, Germany, France, Ireland, United Kingdom, Egypt, Israel, Spain, and Mexico.

Dr. Javidi is a Fellow of the Optical Society of America (OSA) and Fellow of the International Society for Optical Engineering (SPIE). He was awarded the Dennis Gabor Award in Diffractive Wave Technologies by the SPIE in 2005. He was the recipient of the IEEE Lasers and Electro-Optics Society Distinguished Lecturer Award twice in 2003 and 2004. He has been awarded the University of Connecticut Board Of Trustees Distinguished Professor Award, the School Of Engineering Distinguished Professor Award, University of Connecticut Alumni Association Excellence in Research Award, the Chancellor's Research Excellence Award, and the first Electrical and Computer Engineering Department Outstanding Research Award. In 1990, the National Science Foundation named him a Presidential Young Investigator. He has served as the Chairman of the IEEE Lasers and Electro-Optics (LEOS) Technical Committee on Electro-Optics Sensors and Systems, member of the IEEE Neural Networks Council, Chairman of the Optics in Information System Working Group of Optical Engineering Society (SPIE), and Chair of the OSA Image Recognition technical Group. He has served on the program committees of more than two dozens international meetings on information systems sponsored by IEEE, OSA, SPIE, and ICO. He was awarded the IEEE Best Journal Paper Award from IEEE TRANSACTIONS ON VEHICULAR TECHNOLOGY in 2002. He is on the editorial board of the new IEEE JOURNAL OF DISPLAY TECHNOLOGIES.



**Fumio Okano** (Senior Member, IEEE) received the B.S., M.S., and Ph.D. degrees in electrical engineering, from Tohoku University, Sendai, Japan, in 1976, 1978, and 1996, respectively.

He joined Japan Broadcasting Corporation (NHK), Tokyo, Japan, in 1978. Since 1981, he has been engaged in research on high-definition television (HDTV) cameras, HDTV systems, television standards converters, three-dimensional television, and extremely high resolution imagery at NHK Science and Technical Research Laboratories.

Dr. Okano is a member of the Institute of Image Information and Television Engineers of Japan, the Optical Society of America (OSA) and the International Society for Optical Engineering (SPIE).